19-3152; Rev 2; 1/06

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

General Description

The MAX4762–MAX4764/MAX4764A/MAX4765 dual SPDT (single-pole/double-throw) switches feature negative signal capability that allows signals below ground to pass through without distortion. These analog switches operate from a single +1.8V to +5.5V supply and have low 0.6Ω on-resistance, making them ideal for switching audio signals.

The MAX4763/MAX4765 include a comparator that can be used for headphone detection or a mute/send key function. The MAX4764/MAX4764A/MAX4765 have an internal shunt switch to automatically discharge any capacitance at the NO and NC connection points. This reduces click-and-pop sounds that occur when switching audio signals between precharged points.

These SPDT switches are available in space-saving µMAX®, TDFN, thin QFN, and UCSP™ packages and operate over the -40°C to +85°C extended temperature range.

Applications

Cell Phones

PDAs and Handheld Devices

Notebook Computers

MP3 Players

µMAX is a registered trademark and UCSP is a trademark of Maxim Integrated Products, Inc.

Features

- **Distortion-Free Negative Signal Throughput Down to V_{CC} - 5.5V**
- **Comparator for Headphone or Mute Detection (MAX4763/MAX4765)**
- **Internal Shunt Resistor Reduces Click/Pop (MAX4764/MAX4764A/MAX4765)**
- **Low On-Resistance (R_{ON}) 0.6Ω at +2.7V Supply**
- **0.25Ω On-Resistance Flatness**
- **0.05Ω On-Resistance Matching**
- **+1.8V to +5.5V Supply Voltage**
- **-70dB Crosstalk (100kHz)**
- **-65dB Off-Isolation (100kHz)**
- **0.01% Total Harmonic Distortion**
- **Available in µMAX, TDFN, Thin QFN, and UCSP Packages**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4762ETB	-40°C to +85°C	10 TDFN	ACG
MAX4762EUB	-40°C to +85°C	10 µMAX	—
MAX4762EBC-T	-40°C to +85°C	12 UCSP-12	ABU

Ordering Information continued at end of data sheet.

Selector Guide appears at end of data sheet.

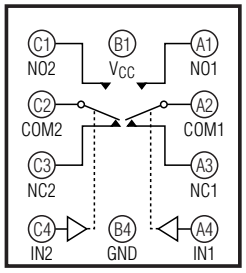
Pin Configurations/Functional Diagrams/Truth Table

TOP VIEW

(BUMP SIDE DOWN)

MAXIM

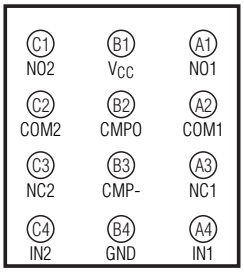
MAX4762/MAX4764



UCSP

MAXIM

MAX4763/MAX4765



UCSP

MAX4762–MAX4764/ MAX4764A/MAX4765		
IN_	**NO_**	**NC_**
0	OFF	ON
1	ON	OFF

SWITCHES SHOWN FOR LOGIC "0" INPUT

Pin Configurations/Functional Diagrams/Truth Table continued at end of data sheet.

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)
V_{CC}, IN_, CMP- ..... -0.3V to +6.0V
COM_, NO_, NC_ ..... (V_{CC} - 6V) to (V_{CC} + 0.3V)
CMPO ..... -0.3V to (V_{CC} + 0.3V)
Closed-Switch Continuous Current COM_, NO_, NC_ ..... ±150mA
Open-Switch Continuous Current NO_, NC_
(MAX4764/MAX4764A/MAX4765) ..... ±30mA
Peak Current COM_, NO_, NC_
(pulsed at 1ms, 50% duty cycle) ..... ±300mA
Peak Current COM_, NO_, NC_
(pulsed at 1ms, 10% duty cycle) ..... ±400mA
Continuous Power Dissipation (T_A = +70°C)
10-Pin TDFN (derate 24.4mW/°C above +70°C) 1951mW
10-Pin µMAX (derate 5.6mW/°C above +70°C) 444mW
12-Bump UCSP (MAX4762/MAX4764)
(derate 5.6mW/°C above +70°C) 449mW
12-Bump UCSP (MAX4763/MAX4765)
(derate 6.5mW/°C above +70°C) 519mW
12-Pin Thin QFN (derate 16.9mW/°C above +70°C) 1349mW
ESD Method 3015.7 ..... ±2kV
Operating Temperature Range ..... -40°C to +85°C
Junction Temperature ..... +150°C
Storage Temperature Range ..... -65°C to +150°C
Lead Temperature (soldering, 10s) ..... +300°C
Bump Temperature (soldering)
Infrared (15s) ..... +220°C
Vapor Phase (60s) ..... +215°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +2.7V to +5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.0V, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range (Note 2)	$V_{NO_}$, $V_{NC_}$, $V_{COM_}$			V_{CC} - 5.5		V_{CC}	V
On-Resistance (Notes 3 and 4)	$R_{ON(NC)}$, $R_{ON(NO)}$	V_{CC} = 2.7V; $V_{NC_}$ or $V_{NO_}$ = V_{CC} - 5.5V, -1V, 0V, 1V, 2V, V_{CC}; $I_{COM_}$ = 100mA	T_A = +25°C		0.6	0.85	Ω
			T_A = T_{MIN} to T_{MAX}			0.95	
On-Resistance Match Between Channels (Notes 3, 4, and 5)	ΔR_{ON}	V_{CC} = 2.7V, $V_{NC_}$ or $V_{NO_}$ = 0V, I_{COM} = 100mA	T_A = +25°C		0.05	0.1	Ω
			T_A = T_{MIN} to T_{MAX}			0.15	
On-Resistance Flatness (Notes 4 and 6)	$R_{FLAT(NC)}$	V_{CC} = 2.7V; $V_{NC_}$ or V_{NC} = -1V, 0V, 1V, 2V, V_{CC}; $I_{COM_}$ = 100mA	T_A = +25°C		0.25	0.4	Ω
			T_A = T_{MIN} to T_{MAX}			0.45	
Shunt Switch Resistance	R_{SH}	MAX4764/MAX4764A/MAX4765 only, $I_{NO_}$ or $I_{NC_}$ = 10mA, V_{CC} = 2.7V	T_A = T_{MIN} to T_{MAX}		25	50	Ω
NO_, NC_ Off-Leakage Current (Notes 8 and 9)	$I_{NO_(OFF)}$, $I_{NC_(OFF)}$	MAX4762/MAX4763 only (Note 7), V_{CC} = 2.7V, switch open; $V_{NC_}$ or $V_{NO_}$ = -2.5V, +2.5V; $V_{COM_}$ = +2.5V, -2.5V	T_A = +25°C	-2		+2	nA
			T_A = T_{MIN} to T_{MAX}	-10		+10	
COM_ On-Leakage Current (Notes 8 and 9)	$I_{COM_(ON)}$	V_{CC} = 2.7V, switch closed; $V_{NC_}$ or $V_{NO_}$ = -2.5V, +2.5V, or floating; $V_{COM_}$ = -2.5V, +2.5V, or floating	T_A = +25°C	-6		+6	nA
			T_A = T_{MIN} to T_{MAX}	-50		+50	

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +2.7V to +5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.0V, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DYNAMIC CHARACTERISTICS							
Turn-On Time	t_{ON}	V_{CC} = 2.7V, V_{NO} = 1.5V; for NO_, $V_{IN_}$ = 0V to V_{CC}; for NC_, $V_{IN_}$ = V_{CC} to 0V; R_L = 300Ω, C_L = 35pF, Figure 2	T_A = +25°C		25	80	ns
			T_A = T_{MIN} to T_{MAX}			80	
			T_A = T_{MIN} to T_{MAX} (MAX4764A)		225	500	
Turn-Off Time	t_{OFF}	V_{CC} = 2.7V, V_{NC} = 1.5V; for NO_, $V_{IN_}$ = V_{CC} to 0V; for NC_, $V_{IN_}$ = 0V to V_{CC}; R_L = 300Ω, C_L = 35pF, Figure 2	T_A = +25°C		20	70	ns
			T_A = T_{MIN} to T_{MAX}			70	
			T_A = T_{MIN} to T_{MAX} (MAX4764A)		225	500	
Break-Before-Make Time Delay	t_D	V_{CC} = 2.7V, $V_{N_}$ = 1.5V, for NO_, $V_{IN_}$ = V_{CC} to 0V; for NC_, $V_{IN_}$ = 0V to V_{CC}; R_L = 300Ω, C_L = 35pF, Figure 3	T_A = +25°C	1	7		ns
Charge Injection	Q	$V_{COM_}$ = 0V, C_L = 1.0nF, Figure 4			150		pC
Off-Isolation (Note 10)	V_{ISO}	f = 100kHz, $V_{COM_}$ = $1V_{RMS}$, R_L = 50Ω, C_L = 5pF, Figure 5			-65		dB
Crosstalk	V_{CT}	f = 100kHz, $V_{COM_}$ = $1V_{RMS}$, R_L = 50Ω, C_L = 5pF, Figure 5			-70		dB
Power-Supply Rejection Ratio	PSRR	f = 10kHz, $V_{COM_}$ = $1V_{RMS}$, R_L = 50Ω, C_L = 5pF			60		dB
On-Channel -3dB Bandwidth	BW	Signal = 0dBm, R_L = 50Ω, C_L = 5pF, Figure 5			27		MHz
Total Harmonic Distortion	THD	f = 20Hz to 20kHz, $V_{COM_}$ = $0.5V_{P-P}$, DC Bias = 0, R_L = 32Ω			0.01		%
NO_, NC_ Off-Capacitance	$C_{NO_(OFF)}$ $C_{NC_(OFF)}$	f = 1MHz, $V_{COM_}$ = $0.5V_{P-P}$, DC Bias = 0, Figure 6			50		pF
COM On-Capacitance	$C_{COM_(ON)}$	f = 1MHz, $V_{COM_}$ = $0.5V_{P-P}$, DC Bias = 0, Figure 6			200		pF
DIGITAL I/O (IN_)							
Input-Logic High Voltage	V_{IH}	V_{CC} = 2.7V to 3.6V		1.4			V
		V_{CC} = 4.2V to 5.5V		2.0			
		V_{CC} = 2.7V to 5.5V (MAX4764A only)		1.6			
Input-Logic Low Voltage	V_{IL}	V_{CC} = 2.7V to 3.6V				0.5	V
		V_{CC} = 4.2V to 5.5V				0.8	
		V_{CC} = 2.7V to 5.5V (MAX4764A only)				0.5	
Input Leakage Current	I_{IN}	$V_{IN_}$ = 0V or V_{CC}		-1		+1	µA
COMPARATOR (MAX4763/MAX4765)							
Comparator Threshold					V_{CC} / 3		V

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +2.7V to +5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.0V, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Comparator Output High Voltage		I_{SOURCE} = 1mA		V_{CC} - 0.4V			V
Comparator Output Low Voltage		I_{SINK} = 1mA				0.4V	V
Comparator Input Leakage Current		V_{CMP-} = 0 to 2.7V		-100		+100	nA
Comparator Switching Time		V_{CC} = 2.7V, V_{CMP-} = 0V to V_{CC}, from 50% of V_{CMP-} to 50% of V_{CMPO}			1	2	µs
POWER SUPPLY							
Power-Supply Range	V_{CC}			1.8		5.5	V
Supply Current	I+	V_{CC} = 5.5V, $V_{IN_}$ = 0V or V_{CC}	MAX4763/MAX4765		5	10	µA
			MAX4762/MAX4764/MAX4764A		0.01	1	
		V_{CC} = 5.5V, $V_{IN_}$ = 1.8V	MAX4764A		5	10	
		V_{CC} = 4.2V, $V_{IN_}$ = 1.8V (Note 11)	MAX4764A		2	5	

Note 1: UCSP and TDFN parts are 100% tested at T_A = +25°C only, and guaranteed by design over the specified temperature range. Thin QFN parts are 100% tested at T_A = +85°C only, and guaranteed by design over the specified temperature range.

Note 2: Signals on COM_, NO_, or NC_ exceeding V_{CC} are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Note 3: Thin QFN and UCSP are guaranteed by design; not production tested.

Note 4: I_{COM} for UCSP is 10mA.

Note 5: $\Delta R_{ON} = R_{ON(MAX)} - R_{ON(MIN)}$.

Note 6: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

Note 7: MAX4764/MAX4764A/MAX4765 have an internal shunt switch when in off-state, which determines OFF current.

Note 8: Leakage parameters are 100% tested at maximum-rated hot operating temperature and guaranteed by design at T_A = +25°C.

Note 9: UCSP parts are guaranteed by design.

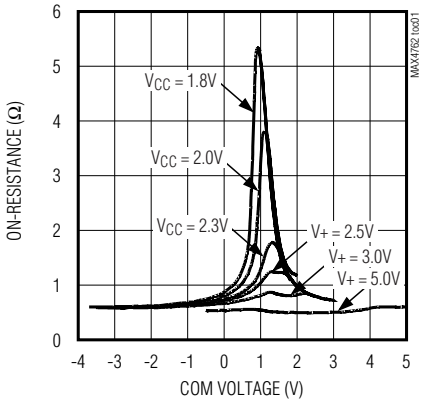
Note 10: Off-isolation = $20\log_{10}$ (V_{COM} / V_{NO}), V_{COM} = output, V_{NO} = input to off switch.

Note 11: Guaranteed by design, not production tested.

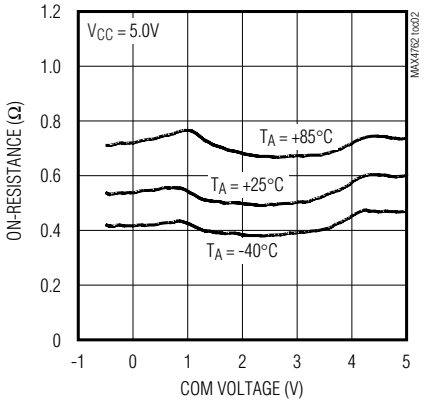
Typical Operating Characteristics

(V_{CC} = 3.0V, T_A = +25°C, unless otherwise noted.)

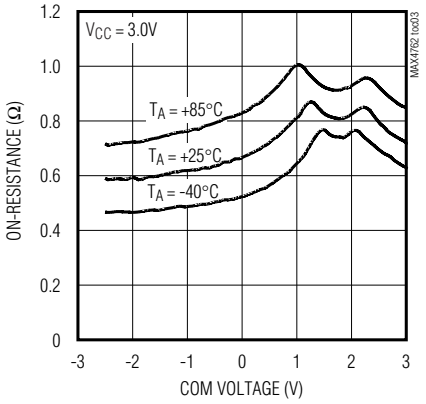
ON-RESISTANCE vs. COM VOLTAGE



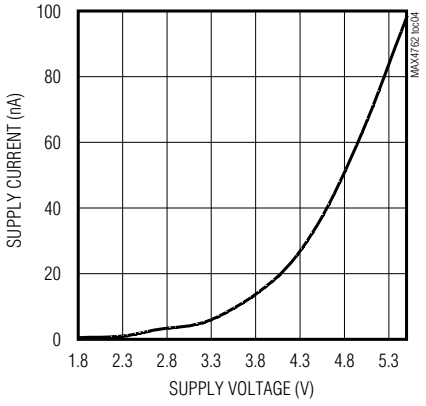
ON-RESISTANCE vs. COM VOLTAGE



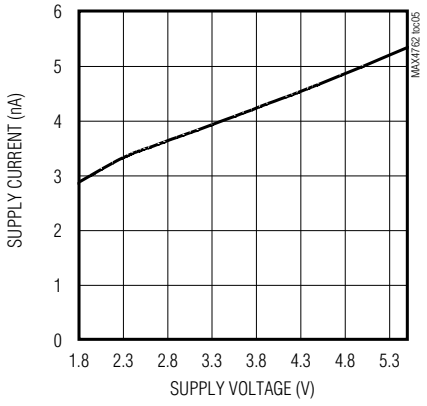
ON-RESISTANCE vs. COM VOLTAGE



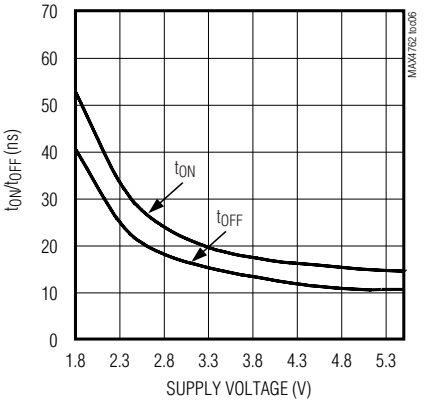
MAX4762/MAX4764/MAX4764A SUPPLY CURRENT vs. SUPPLY VOLTAGE



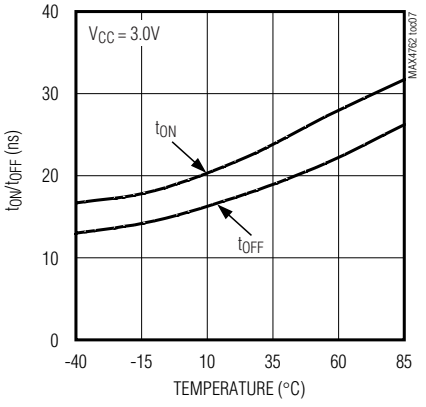
MAX4763/MAX4765 SUPPLY CURRENT vs. SUPPLY VOLTAGE



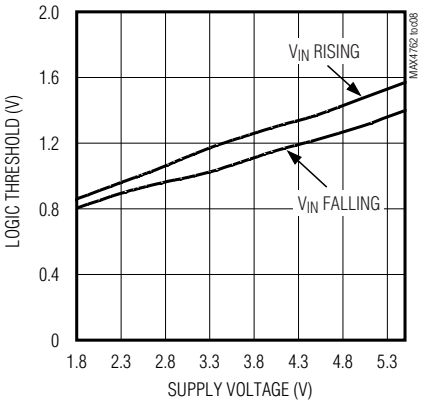
MAX4762–MAX4765 TURN-ON/TURN-OFF TIME vs. SUPPLY VOLTAGE



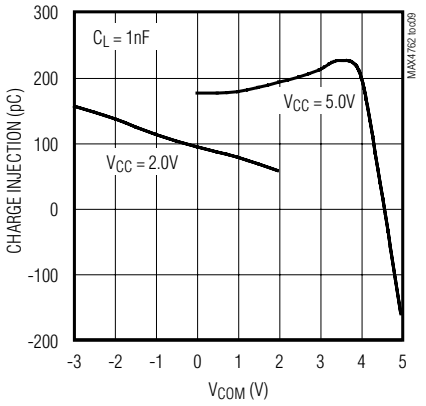
MAX4762–MAX4765 TURN-ON/TURN-OFF TIME vs. TEMPERATURE



MAX4762–MAX4765 LOGIC THRESHOLD vs. SUPPLY VOLTAGE



CHARGE INJECTION vs. V_{COM}

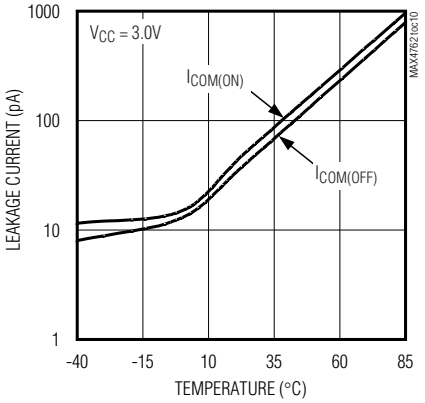


Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

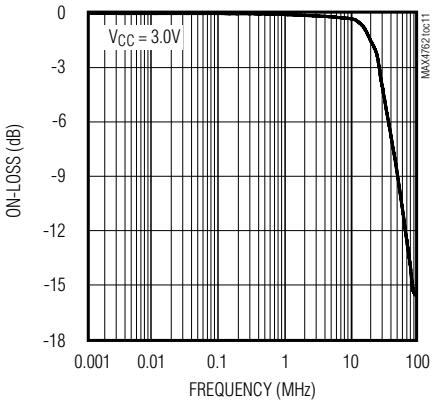
Typical Operating Characteristics (continued)

(V_{CC} = 3.0V, T_A = +25°C, unless otherwise noted.)

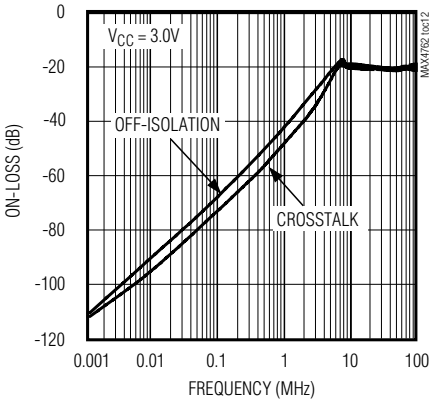
LEAKAGE CURRENT vs. TEMPERATURE



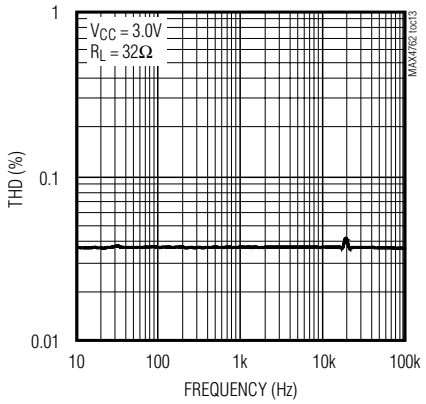
FREQUENCY RESPONSE vs. ON-LOSS



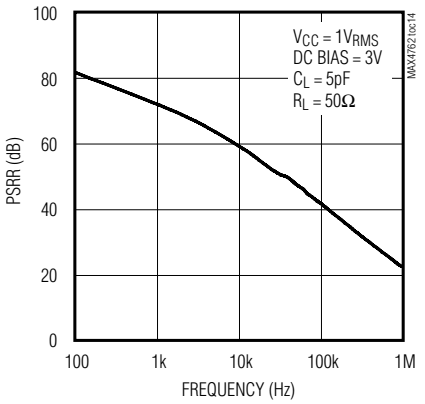
FREQUENCY RESPONSE OFF-ISOLATION, CROSSTALK



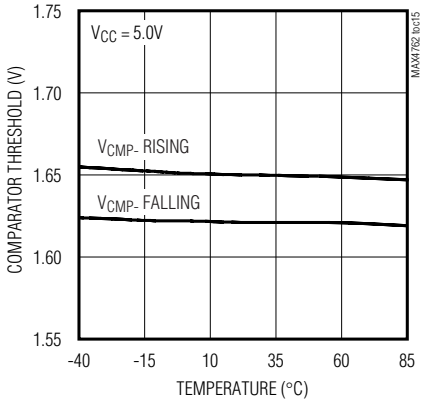
TOTAL HARMONIC DISTORTION vs. FREQUENCY



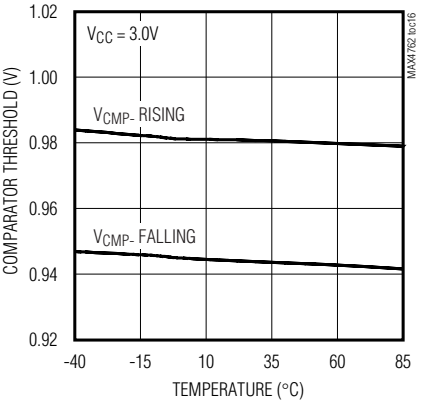
POWER-SUPPLY REJECTION RATIO vs. FREQUENCY



COMPARATOR THRESHOLD vs. TEMPERATURE



COMPARATOR THRESHOLD vs. TEMPERATURE



Pin Description (MAX4762/MAX4764/MAX4764A)

PIN		NAME	FUNCTION
10-µMAX 10-TDFN	12-UCSP		
1	B1	V_{CC}	Positive-Supply Voltage Input
2	A1	NO1	Analog Switch 1—Normally Open Terminal
3	A2	COM1	Analog Switch 1—Common Terminal
4	A3	NC1	Analog Switch 1—Normally Closed Terminal
5	A4	IN1	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.
6	B4	GND	Ground
7	C4	IN2	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to NO2.
8	C3	NC2	Analog Switch 2—Normally Closed Terminal
9	C2	COM2	Analog Switch 2—Common Terminal
10	C1	NO2	Analog Switch 2—Normally Open Terminal
EP (TDFN only)	—	EP	Exposed pad for TDFN package. Connect to GND.

Pin Description (MAX4763/MAX4765)

PIN		NAME	FUNCTION
12-Thin QFN	12-UCSP		
1	A2	COM1	Analog Switch 1—Common Terminal
2	A3	NC1	Analog Switch 1—Normally Closed Terminal
3	A4	IN1	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.
4	B3	CMP-	Comparator Inverting Input
5	B4	GND	Ground
6	C4	IN2	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to NO2.
7	C3	NC2	Analog Switch 2—Normally Closed Terminal
8	C2	COM2	Analog Switch 2—Common Terminal
9	C1	NO2	Analog Switch 2—Normally Open Terminal
10	B2	CMPO	Comparator Output
11	B1	V_{CC}	Positive-Supply Voltage Input
12	A1	NO1	Analog Switch 1—Normally Open Terminal
EP	—	EP	Exposed pad. Connect to GND.

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

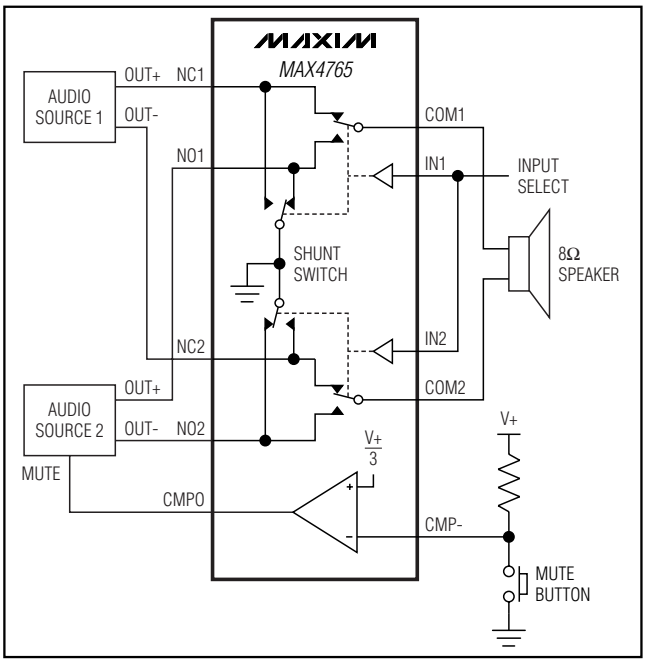


Figure 1. Typical Operating Circuit

Detailed Description

The MAX4762–MAX4764/MAX4764A/MAX4765 are low on-resistance, low-voltage, dual SPDT analog switches that operate from a +1.8V to +5.5V supply and are fully specified for nominal 3.0V applications. The devices feature a negative signal capability that allows signals below ground to pass through without distortion and have break-before-make switching.

The MAX4763/MAX4765 feature a comparator that can be used for headphone or mute detection. The comparator threshold is internally generated to be approximately 1/3 of V_{CC}. The MAX4764/MAX4764A/MAX4765 feature an internal shunt switch to discharge any capacitance at the NO and NC connection points. This reduces the click-and-pop sounds that occur when switching audio signals.

Applications Information

Digital Control Inputs

The MAX4762–MAX4764/MAX4764A/MAX4765 logic inputs accept up to +5.5V, regardless of supply voltage. For example, with a +3.3V supply, IN_ can be driven low to GND and high to +5.5V allowing for mixing of logic levels in a system. Driving IN_ rail-to-rail minimizes power consumption. For a +1.8V supply voltage, the logic thresholds are 0.5V (low) and 1.4V (high); for a +5V supply voltage, the logic thresholds are 0.8V (low) and 2.0V (high).

Analog Signal Levels

The on-resistance of the MAX4762–MAX4764/MAX4764A/MAX4765 changes very little for analog input signals across the entire supply voltage range (see the *Typical Operating Characteristics*). The switches are bidirectional, so the NO_, NC_, and COM_ pins can be either inputs or outputs.

The MAX4762–MAX4764/MAX4764A/MAX4765 pass signals as low as V_{CC} - 5.5V, including signals below ground with minimal distortion.

Comparator (MAX4763/MAX4765)

The MAX4763/MAX4765 include a comparator that can be used for mute and headphone detection functions. The positive terminal of the comparator is internally set to V_{CC} / 3. When the negative terminal (CMP-) is below the threshold, the comparator output (CMPO) is a logic high. When CMP- rises above V_{CC} / 3, CMPO is a logic low.

The comparator threshold of V_{CC} / 3 allows for detection of headphones because headphone audio signals are typically biased to V_{CC} / 2.

Shunt Switch (MAX4764/MAX4764A/MAX4765)

The 100Ω shunt switches on the MAX4764/MAX4764A/MAX4765 automatically discharge any capacitance at the NC_ or NO_ terminals when they are unconnected to COM_. This reduces audible click-and-pop sounds that occur when switching between audio sources.

Audible clicks and pops are caused when a step DC voltage is switched into the speaker. By automatically discharging the side that is not connected, any residual DC voltage is removed, thereby reducing the clicks and pops.

Power-Supply Sequencing and Overvoltage Protection

Caution: Do not exceed the absolute maximum ratings since stresses beyond the listed ratings may cause permanent damage to the device.

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V_{CC} before applying analog signals, especially if the analog signal is not current-limited.

UCSP Applications Information

For the latest application details on UCSP construction, dimensions, tape carrier information, printed circuit board techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, go to the Maxim's website at www.maxim-ic.com/ucsp and search for the Application Note, "UCSP—A Wafer-Level Chip-Scale Package."

Test Circuits/Timing Diagrams

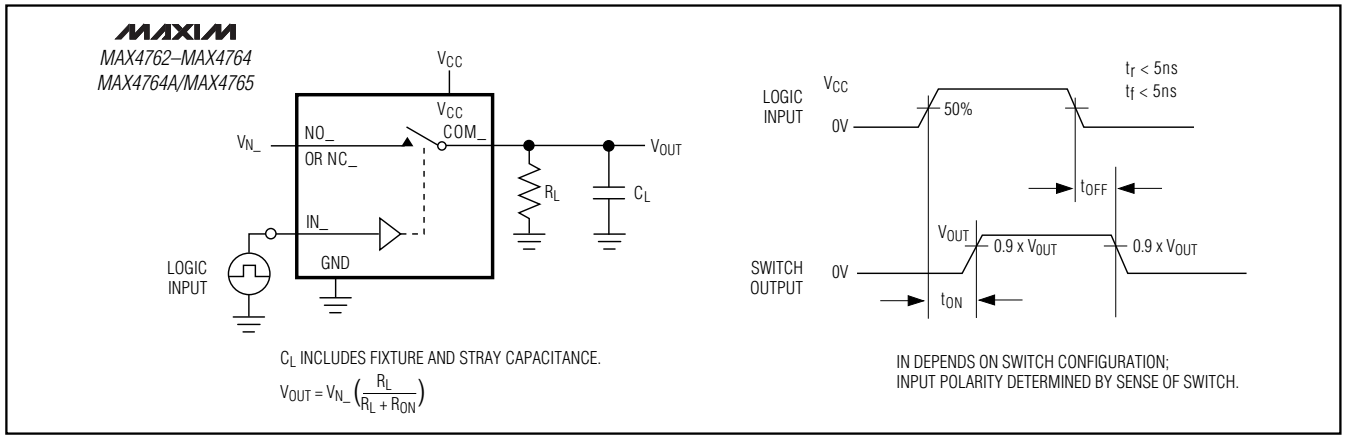


Figure 2. Switching Time

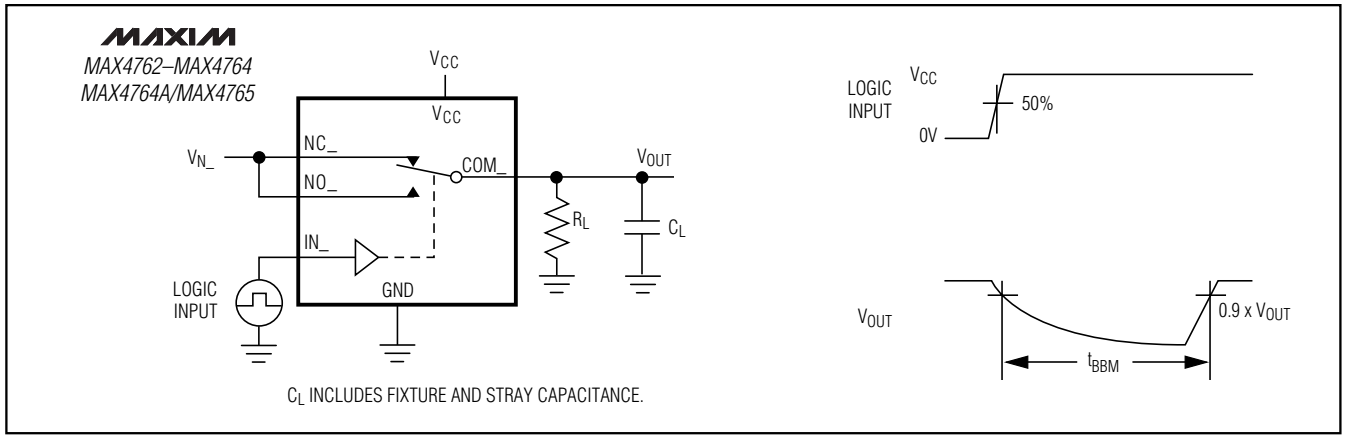


Figure 3. Break-Before-Make Interval

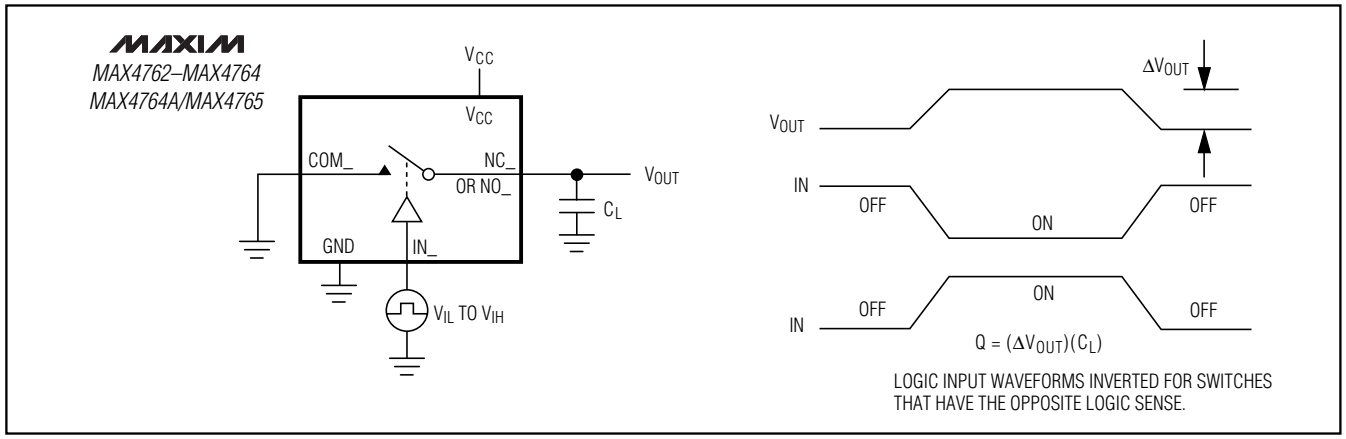


Figure 4. Charge Injection

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

Test Circuits/Timing Diagrams (continued)

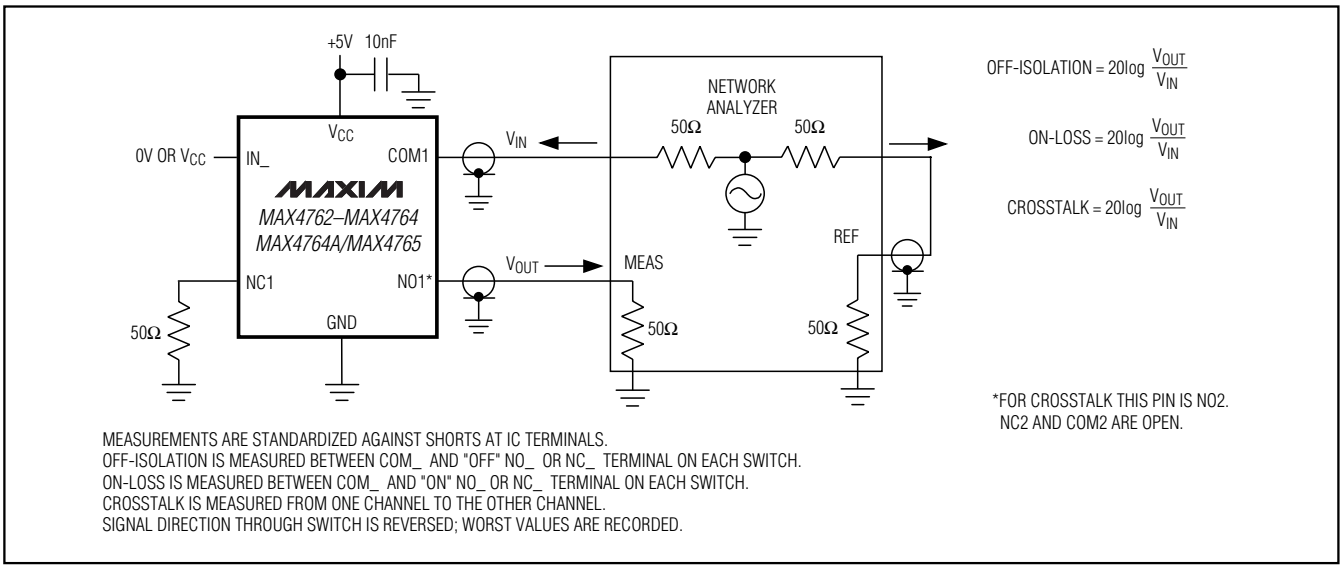


Figure 5. On-Loss, Off-Isolation, and Crosstalk

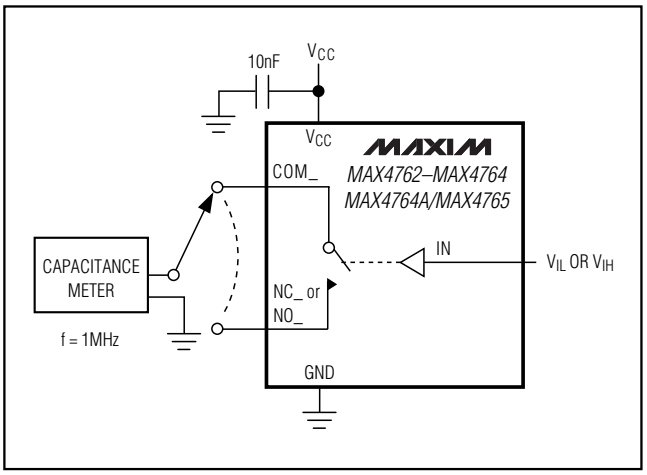


Figure 6. Channel Off/On-Capacitance

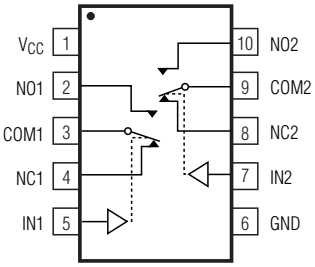
Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

Pin Configurations/Functional Diagrams/Truth Table (continued)

TOP VIEW

MAXIM

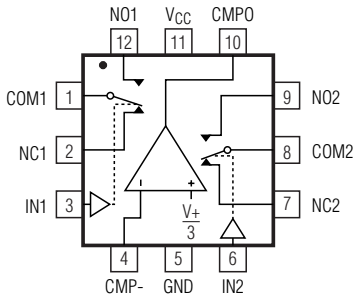
MAX4762/MAX4764/MAX4764A



µMAX/TDFN

MAXIM

MAX4763/MAX4765



THIN QFN

Selector Guide

PART	COMPARATOR	SHUNT	PACKAGE SIZE (mm)
MAX4762EBC-T	No	No	1.5 x 2.0
MAX4762ETB	No	No	3.0 x 3.0
MAX4762EUB	No	No	3.0 x 5.0
MAX4763EBC-T	Yes	No	1.5 x 2.0
MAX4763ETC	Yes	No	4.0 x 4.0
MAX4764EBC-T	No	Yes	1.5 x 2.0
MAX4764ETB	No	Yes	3.0 x 3.0
MAX4764AETB	No	Yes	3.0 x 3.0
MAX4764EUB	No	Yes	3.0 x 5.0
MAX4765EBC-T	Yes	Yes	1.5 x 2.0
MAX4765ETC	Yes	Yes	4.0 x 4.0

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4763EBC-T	-40°C to +85°C	12 UCSP-12	ABS
MAX4763ETC	-40°C to +85°C	12 Thin QFN	AAED
MAX4764ETB	-40°C to +85°C	10 TDFN	ACH
MAX4764EUB	-40°C to +85°C	10 µMAX	—
MAX4764EBC-T	-40°C to +85°C	12 UCSP-12	ABV
MAX4764AETB	-40°C to +85°C	10 TDFN	AQP
MAX4765EBC-T	-40°C to +85°C	12 UCSP-12	ABT
MAX4765ETC	-40°C to +85°C	12 Thin QFN	AAEE

Chip Information

TRANSISTOR COUNT: 769

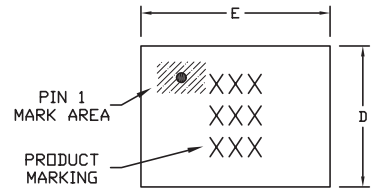
PROCESS: BiCMOS

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

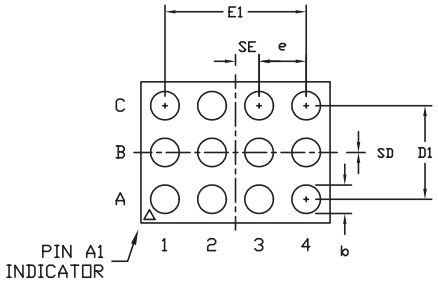
12L, UCSP 4x3.EPS



TOP VIEW

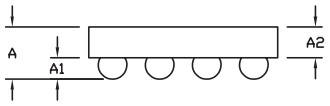
COMMON DIMENSIONS	
A	0.62+0.05-0.08
A1	0.29±0.02
A2	0.33 REF.
b	ø0.35±0.03
D1	1.00 BASIC
E1	1.50 BASIC
e	0.50 BASIC
SD	0.00 BASIC
SE	0.25 BASIC

PKG. CODE	VARIABLE DIMENSIONS		DEPOPULATED SOLDER BALLS
	D	E	
B12-1	1.54±0.05	2.02±0.05	NONE
B12-2	1.54±0.05	2.02±0.05	B3
B12-3	1.54±0.05	2.12±0.05	NONE
B12-4	1.54±0.05	2.02±0.05	B2, B3
B12-5	1.64±0.05	2.12±0.05	B2
B12-6	1.64±0.05	2.12±0.05	B3
B12-7	1.54±0.05	2.02±0.05	B1, B3
B12-8	1.54±0.05	2.02±0.05	B2
B12-9	1.54±0.05	2.12±0.05	B2, B3
B12-10	1.54±0.05	2.02±0.05	B1, B2, B3, B4
B12-11	1.54±0.05	2.02±0.05	A2, C3



BOTTOM VIEW

NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. PRODUCT MARKING: NUMBER OF CHARACTERS AND LINES VARY PER PRODUCT.



SIDE VIEW

DALLAS SEMICONDUCTOR MAXIM
PROPRIETARY INFORMATION

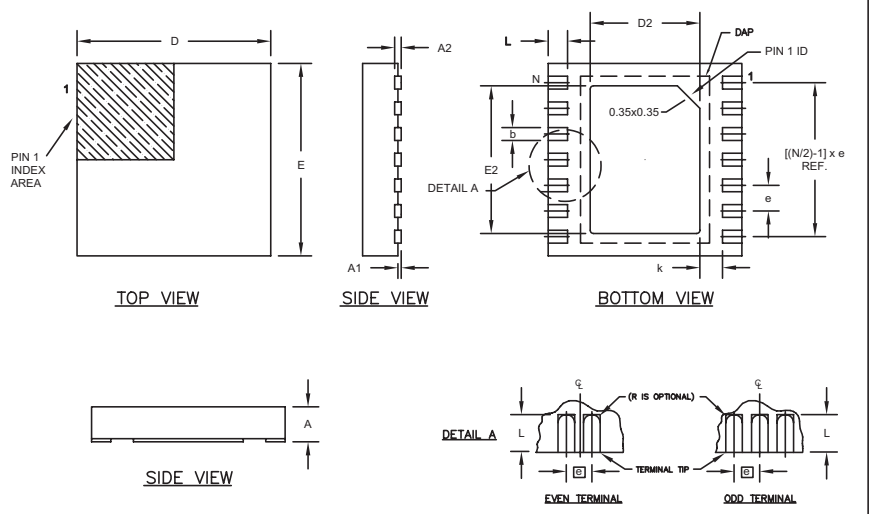
TITLE: PACKAGE OUTLINE, 4x3 UCSP

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0104	F	1/1

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

6, 8, &10L, DFN THIN.EPS



DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	G	1/2

-DRAWING NOT TO SCALE-

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN.	
A2	0.20 REF.	

PACKAGE VARIATIONS								
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e	DOWNBONDS ALLOWED
T633-1	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO
T833-1	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	YES
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF	NO
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF	YES
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF	NO

NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
6. "N" IS THE TOTAL NUMBER OF LEADS.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	G	2/2

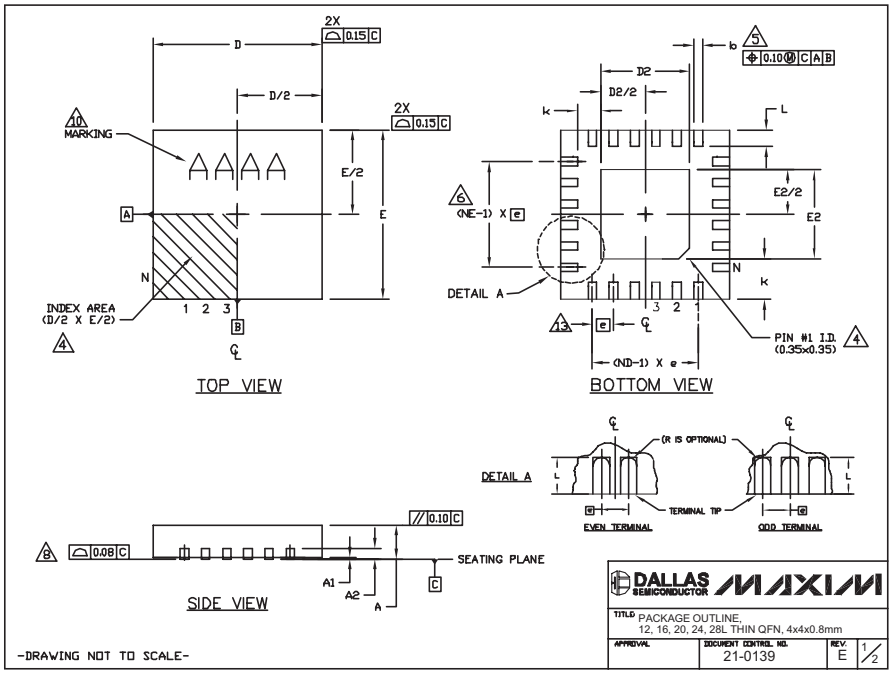
-DRAWING NOT TO SCALE-

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

24L QFN THIN.EPS



COMMON DIMENSIONS

PKG	12L 4x4			16L 4x4			20L 4x4			24L 4x4			28L 4x4		
REF.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05
A2	0.20 REF			0.20 REF			0.20 REF			0.20 REF			0.20 REF		
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30	0.15	0.20	0.25
D	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
E	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
e	0.80 BSC.			0.65 BSC.			0.50 BSC.			0.50 BSC.			0.40 BSC.		
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50
N	12			16			20			24			28		
ND	3			4			5			6			7		
NE	3			4			5			6			7		
Jedec Var.	WGGB			WGGC			WGGD-1			WGGD-2			WGGE		

EXPOSED PAD VARIATIONS

PKG. CODES	D2			E2			DOWN BONDS ALLOWED
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
T1244-3	1.95	2.10	2.25	1.95	2.10	2.25	YES
T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	NO
T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	YES
T1644-4	1.95	2.10	2.25	1.95	2.10	2.25	NO
T2044-2	1.95	2.10	2.25	1.95	2.10	2.25	YES
T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	NO
T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	YES
T2444-3	2.45	2.60	2.63	2.45	2.60	2.63	YES
T2444-4	2.45	2.60	2.63	2.45	2.60	2.63	NO
T2844-1	2.50	2.60	2.70	2.50	2.60	2.70	NO

NOTES:

1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
3. N IS THE TOTAL NUMBER OF TERMINALS.
4. THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
5. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
6. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
8. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT FOR T2444-3, T2444-4 AND T2844-1.
10. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
11. COPLANARITY SHALL NOT EXCEED 0.08mm
12. WARPAGE SHALL NOT EXCEEND 0.10mm
13. LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "e", ±0.05.
14. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY

-DRAWING NOT TO SCALE-

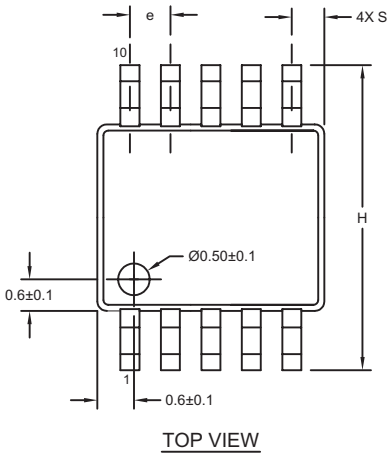
DALLAS SEMICONDUCTOR MAXIM
TITLE PACKAGE OUTLINE, 12, 16, 20, 24, 28L THIN QFN, 4x4x0.8mm
APPROVAL
DOCUMENT CONTROL NO. 21-0139
REV. E
2/2

Low-Voltage, Dual SPDT, Audio Clickless Switches with Negative Rail Capability

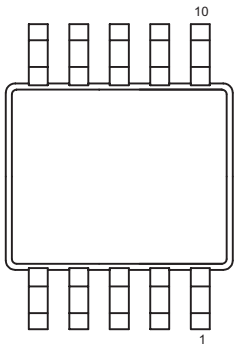
Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

10LUMAX.EPS

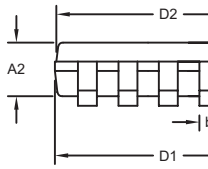


TOP VIEW

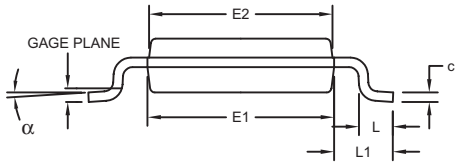


BOTTOM VIEW

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	-	0.043	-	1.10
A1	0.002	0.006	0.05	0.15
A2	0.030	0.037	0.75	0.95
D1	0.116	0.120	2.95	3.05
D2	0.114	0.118	2.89	3.00
E1	0.116	0.120	2.95	3.05
E2	0.114	0.118	2.89	3.00
H	0.187	0.199	4.75	5.05
L	0.0157	0.0275	0.40	0.70
L1	0.037 REF		0.940 REF	
b	0.007	0.0106	0.177	0.270
e	0.0197 BSC		0.500 BSC	
c	0.0035	0.0078	0.090	0.200
S	0.0196 REF		0.498 REF	
α	0°	6°	0°	6°



FRONT VIEW



SIDE VIEW

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. CONTROLLING DIMENSION: MILLIMETERS.
4. MEETS JEDEC MO-187C-BA.

DALLAS SEMICONDUCTOR MAXIM

PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE, 10L uMAX/uSOP

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0061	I	1/1

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